

# Technical Data Sheet

Customer Part No.:

Inhere Part No.: S3433EPUY00T-001-AM

Part Name: 3433 Yellow LED

Spec Issue Date: 2024-12-23

Revision No.: A

To Customer:

We submit herewith the following information for your approval:

- Sample       OQC Inspection Record       LED Dimension  
 Electrical Characteristics Curve       Internal Circuit Diagram  
 Soldering recommendation

Prepared by : Lily

Checked by : Tom

Approved by : Evan

Date : 2024-12-23

Date : 2024-12-23

Date : 2024-12-23

Customer Opinion

- Approve and no objection  
 Reject with the following reason:

**inhere**   
light for your mind  
银河光电

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## Features

3.40mm×3.30mm LED, 1.90mm thickness

Low power consumption

Wide view angle

Package: 2000pcs/reel

RoHS Compliant

Compliance to automotive standard: AEC-Q102

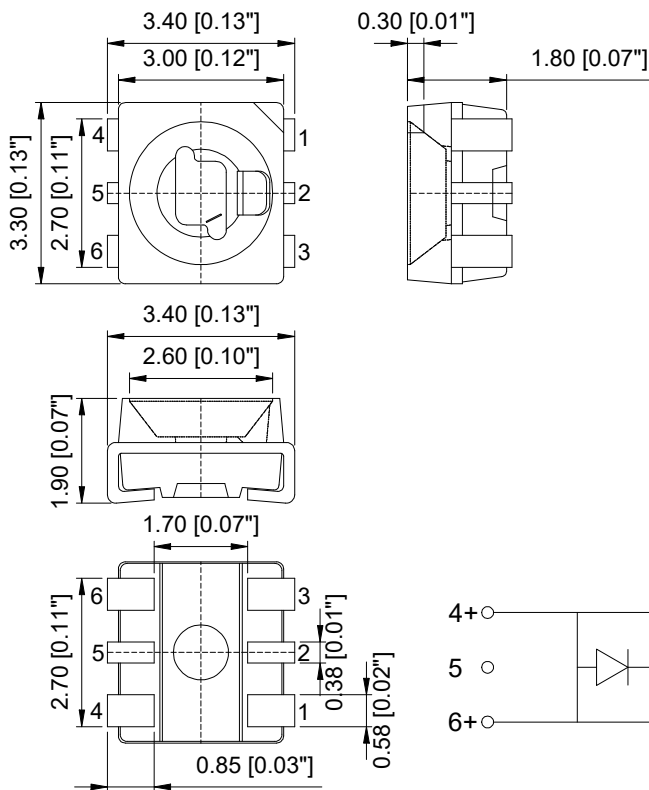
## Applications

Automotive backlighting or indicator

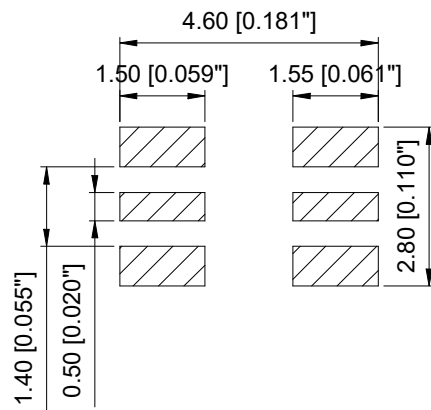
Ideal for back light and indicator

Various colors and lens types available

## Package Outlines



## Recommend Pad Layout



Part No.	Emitted color	Dice	Lens color
S3433EPUY00T-001-AM	Yellow	AlGaInP	Water transparent

### Notes:

All dimensions are in millimeters (inches).

Tolerances are  $\pm 0.1\text{mm}$  (0.004inch) unless otherwise noted.

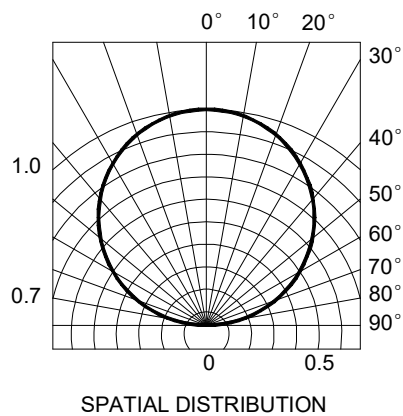
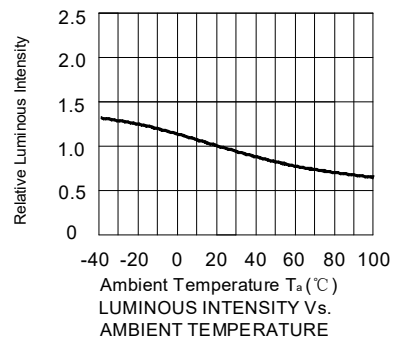
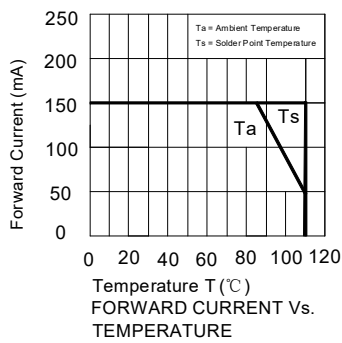
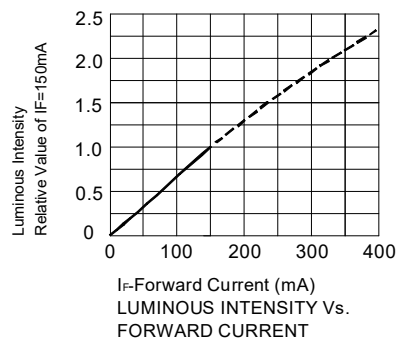
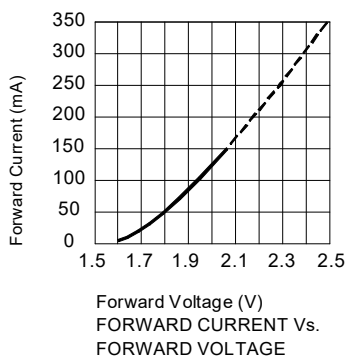
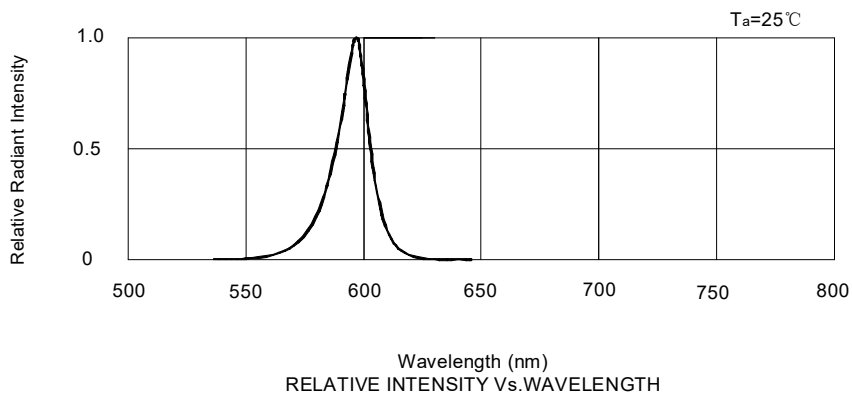
**Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Value	Unit
Forward current	I <sub>f</sub>	200	mA
Peak pulsing current (1/10 duty f=1kHz)	I <sub>fp</sub>	300	mA
Power dissipation	P <sub>d</sub>	480	mW
ESD(HBM,R=100kΩ ,C=100pF)	--	2000	V
Reverse voltage	V <sub>r</sub>	5	V
Operating temperature	T <sub>op</sub>	-40 ~+110	°C
Storage temperature	T <sub>stg</sub>	-40 ~+110	°C
Junction temperature	T <sub>j</sub>	125	°C
Humidity sensitive level	MSL	2a	--

**Electro-Optical Characteristics (Ta=25°C)**

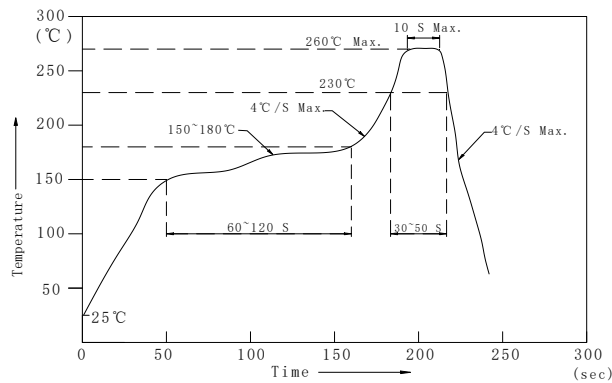
Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Wavelength at peak emission	I <sub>f</sub> =150mA	λ <sub>p</sub>	--	590	--	nm
Spectral half bandwidth	I <sub>f</sub> =150mA	Δλ	--	15	--	nm
Dominant wavelength	I <sub>f</sub> =150mA	λ <sub>d</sub>	585	--	595	nm
Forward voltage	I <sub>f</sub> =150mA	V <sub>f</sub>	1.8	--	2.4	V
Luminous intensity	I <sub>f</sub> =150mA	I <sub>v</sub>	4500	--	9000	mcd
Viewing angle	I <sub>f</sub> =150mA	2θ <sub>1/2</sub>	--	120	--	Deg
Reverse current	V <sub>r</sub> =5V	I <sub>r</sub>	--	--	10	μA

# Optical Characteristic Curves



## Reflow Profile

### ■ Reflow Temp/Time



### Notes:

1. We recommend the reflow temperature 245°C (±5°C), the maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Times of reflow process shall be 2 or less.

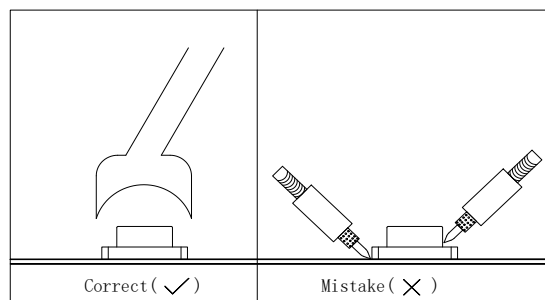
### ■ Soldering iron

Basic spec is  $\frac{6}{\lambda}$  5sec when 320°C (±20°C). If temperature is higher, time should be shorter (+10°C → -1sec).

Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 350°C.

### ■ Rework

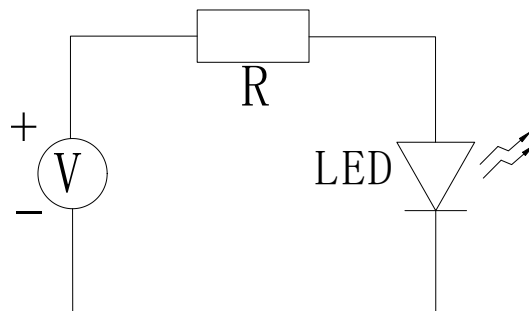
1. Customer must finish rework within 5 sec under 340°C.
2. The head of iron cannot touch copper foil.
3. Twin-head type is preferred.



- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

## Test Circuit and Handling Precautions

### ■ Test circuit



### ■ Handling precautions

#### 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

2.2 Shelf life in sealed bag: 12 month at <math>5^{\circ}\text{C}\sim 30^{\circ}\text{C}</math> and <math>< 30\%</math> R.H. after the package is opened, the products should be used within 4 weeks or they should be keeping to stored at  $\leq 20$  R.H. with zip-lock sealed.

#### 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 4 weeks.

The Condition is:  $65\pm 5^{\circ}\text{C}/24\text{hrs}$ .

## Test Items and Results of Reliability (1)

### TEST GROUP A – ACCELERATED ENVIRONMENT STRESS TESTS

Item No.	Test Item	Standard	Test Condition	Qty	Conclusion
A1	Pre-conditioning (PC)	JEDEC JESD22-A113H-2016 JEDEC J-STD-020E : 2015	125°C 24 hrs,60°C/60%RH 120hrs,3X reflow	312 pcs	Pass
A2a	Wet High Temperature Operating Life1 (WHTOL1)	JEDEC JESD22-A101D.01-2021	Pre-conditioning,85°C/85%RH,1000hrs,IF=150mA, 30min ON/OFF	26pcs *3	Pass
A2b	Wet High Temperature Operating Life2 (WHTOL2)	JEDEC JESD22-A101D.01-2021	Pre-conditioning,85°C/85%RH,1000hrs,IF=85mA	26pcs *3	Pass
A3a	Power Temperature Cycling (PTC)	JEDEC JESD22-A105C-2004 R2011	Pre-conditioning,-40°C~100°C,Transfer time 20min,Dwell time 10min,5min ON/OFF,1000cycles,IF=85mA	26pcs *3	Pass
A4	Temperature Cycling (TC)	JEDEC JESD22-A104F-2020	Pre-conditioning,-40°C~100°C,transfer time <10Sec,dwell time 15min,1000cycles	26pcs *3	Pass

### TEST GROUP B – ACCELERATED LIFETIME STRESS TESTS

Item No.	Test Item	Standard	Test Condition	Qty	Conclusion
B1a	High Temperature Operating Life1 (HTOL1)	JEDEC JESD22-A108F-2017	Tsolder=101°C,Ta=100°C,1000hrs,IF=85mA	26pcs *3	Pass
B1b	High Temperature Operating Life2 (HTOL2)	JEDEC JESD22-A108F-2017	Tsolder=102°C,Ta=100°C,1000hrs,IF=150mA	26pcs *3	Pass
B3	Pulsed Life (PLT)	JEDEC JESD22-A108F-2017	Tsolder=55°C,Ta=53°C,IF=300mA,tp=100µs, D=3%,1000hrs	26pcs *3	Pass

### TEST GROUP C – PACKAGE ASSEMBLY INTEGRITY TESTS

Item No.	Test Item	Standard	Test Condition	Qty	Conclusion
C1	Destructive Physical Analysis (DPA)	AEC-Q102 : 2020 Appendix 6	Check the internal state of LED with microscope after De-Cap.	16pcs	Pass
C2	Physical Dimension (PD)	JESD22-B100B-2003 (R2016)	Measure the external physical dimensions of the LED by Microscope.	10pcs *3	Pass
C3	Wire Bond Pull (WBP)	MIL-STD-750-2A w/CHANGE 4 : 2020,Method 2037.1 Condition C	Test Speed : 300 µm/s	10pcs *3	Pass
C4	Wire Bond Shear (WBS)	JEDEC JESD22-B116B-2017	Shear Speed : 300 µm/s Shear Height: 2 µm Ball bond areas : 7.78mil <sup>2</sup>	10pcs *3	Pass
C5	Die Shear (DS)	MIL-STD-750-2A w/CHANGE 4 : 2020,Method 2017.3 Condition A	Shear Speed : 300 µm/s Shear Height : 50 µm Die areas : 0.35 mm <sup>2</sup>	5pcs *3	Pass
C7	Dew (DEW)	AEC-Q102-001 : 2020	IF=85mA,65hrs	26pcs *3	Pass

## Test Items and Results of Reliability (2)

### TEST GROUP C – PACKAGE ASSEMBLY INTEGRITY TESTS

No.	Test Item	Standard	Test Condition	Qty	Conclusion
C9	Thermal resistance (TR) *	JESD51-50-2012	Implementation of the Electrical Test Method for the Measurement of Real Thermal Resistance and Impedance of Light-Emitting Diodes with Exposed Cooling.	10pcs *3	Pass
C10	Solderability (SD)	Solderability (SD) 2017 Test S1	Test type : Pb-free solderability, Pretreatment Conditions : 155°C,4 hours, Oven : 250°C,3min	10 pcs*3	Pass
C12	Hydrogen Sulphide (H2S) *	IEC60068-2-43 : 2003	Ta=40°C,RH=90%,336 hrs H2S concentration : 15x 10 <sup>-6</sup>	26pcs*3	Pass
C13	Flowing Mixed Gas (FMG)*	IEC 60068-2-60 : 2015	500hrs at 25°C/75%RH H2S concentration : 10 x 10 <sup>-9</sup> SO2 concentration : 200 x 10 <sup>-9</sup> NO2 concentration : 200 x 10 <sup>-9</sup> Cl2 concentration : 10 x 10 <sup>-9</sup>	26pcs*3	Pass
C14	Board Flex (BF)	AEC-Q102-002-Rev-2020	Testing speed : 50mm/min Span : 90mm Radius of loading and supports edge : 10mm Compress 2mm and keep 5s Status : Powered on	10pcs*3	Pass

### TEST GROUP E – ELECTRO-OPTICAL VERIFICATION TESTS

No.	Test Item	Standard	Test Condition	Qty	Conclusion
E0	External Visual (EV)	JEDEC JESD22-B101C-2015	Visual inspection	1093pcs	Pass
E1	Pre- and Post- Stress Electrical and Photometric Test (TEST)	AEC-Q102-Rev_A-2020 appendix 5	Measure Vf,Φv,Cx,Cy at IF=150mA	870pcs	Pass
E2	Parametric Verification (PV)	Client's specification	Test Temp. : -40°C,100°C Test Current : IF=150mA	26pcs*3	Pass
E3	Electrostatic Discharge Human Body Model (HBM)	ANSI/ESDA/JEDEC JS-001-2017	Test voltage : ±8000V Number of Pulses : 1 times Interval time : 0.3 sec	10pcs*3	Pass
E4	Electrostatic Discharge Charged Device Model (CDM)	AEC-Q101-005-REV-A-2019 option 3	±500V,±750V,±1000V Zap 3 times	10pcs*3	Pass

### TEST GROUP G – CAVITY PACKAGE INTEGRITY TESTS

No.	Test Item	Standard	Test Condition	Qty	Conclusion
G2	Vibration Variable Frequency (VVF)	JEDEC JESD22-B103B.01 : 2016 condition 1	Frequency Range : (20Hz~2000Hz) Amplitude(p-p) : 1.5 mm (20Hz~81.3Hz) Acceleration : 20g (81.3Hz~2000Hz) Sweep Rate : 4 min/cycle Orientation : X axis,Y axis,Z axis 4 cycles.	10pcs*3	Pass
G3	Mechanical Shock (MS)	JEDEC JESD22-B110B01 : 2019	Pulse Shape : Half-sine Acceleration : 1500g Pulse Width : 0.5ms Orientation : ±X axis,±Y axis,±Z axis Shock Times : 5 times/direction,total 30 times	10pcs*3	Pass



**Forward Voltage Rank Combination (IF=150mA)**

Rank	Min.	Max.	Unit
7	1.8	1.9	v
8	1.9	2.0	
9	2.0	2.1	
A	2.1	2.2	
B	2.2	2.3	
C	2.3	2.4	

**Luminous Flux Rank Combination (IF=150mA)**

Rank	Min.	Max.	Unit
YY	4500	5600	lm
YZ	5600	7150	
Ya	7150	9000	

**Dominant Wavelength Rank Combination (IF=150mA)**

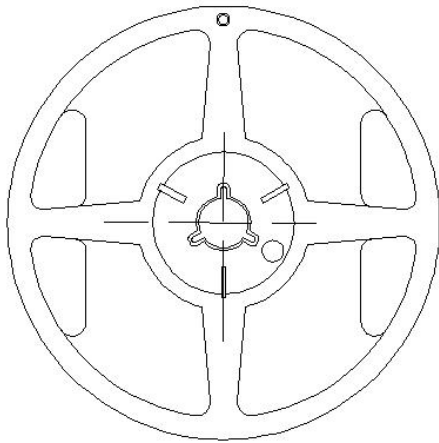
Rank	Min.	Max.	Unit
Yb	583	586	nm
Yc	586	589	
Yd	589	592	
Ye	592	595	

**Notes:**

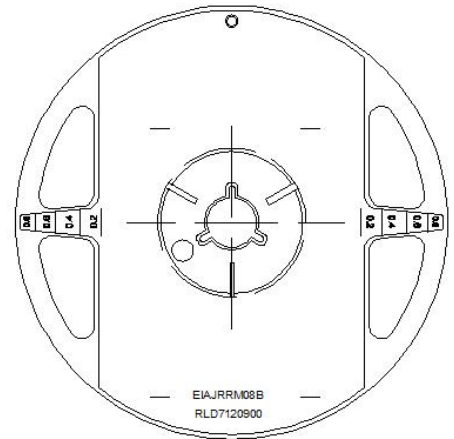
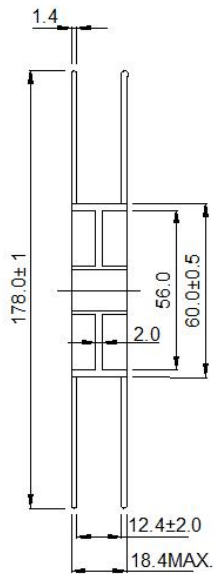
1. The tolerance of forward voltage is  $\pm 0.1V$ .
2. The tolerance of luminous flux ( $\Phi$ ) is  $\pm 11\%$ .
3. The tolerance of dominant wavelength is  $\pm 1nm$ .
4. This specification is preliminary.
5. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

### 3433 Series SMD Top LED Lamps Packaging Specifications

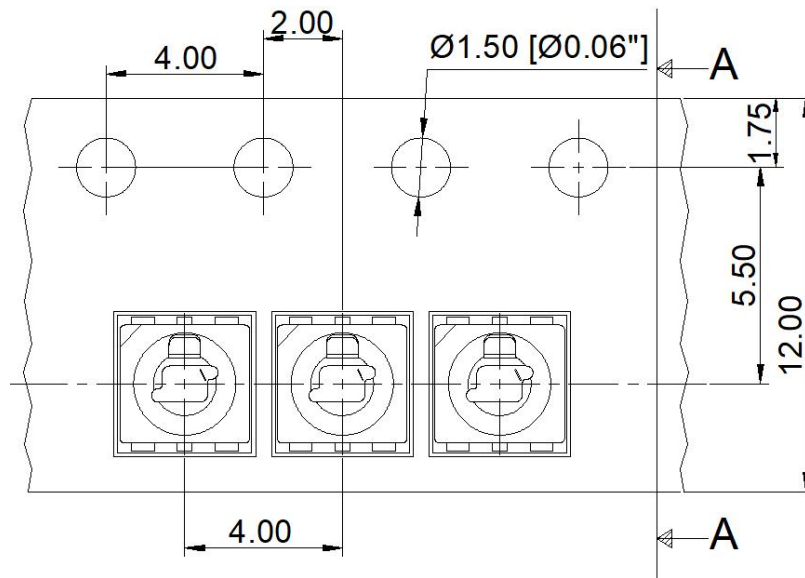
- Feeding Direction



- Dimensions of Reel (Unit: mm)



- Dimensions of Tape (Unit: mm)

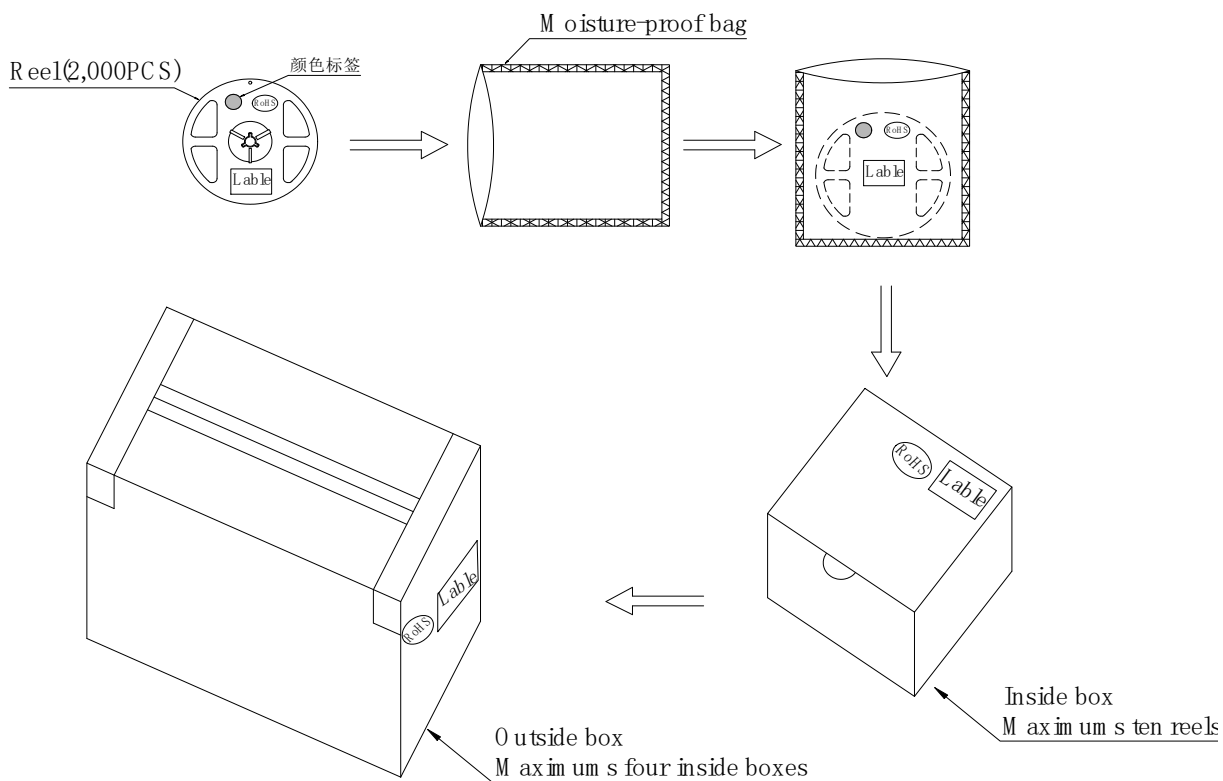


Notes:

1. Empty component pockets are sealed with top cover tape.
2. The maximum number of missing lamps is two.
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 2,000pcs/Reel.

### 3433 Series SMD Top LED Lamps Packaging Specifications

- Packaging specifications



**Notes:**

Reeled products (numbers of products are 2,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 20,000pcs) packed in an inside box (about size: 220x 230 x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x 260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.